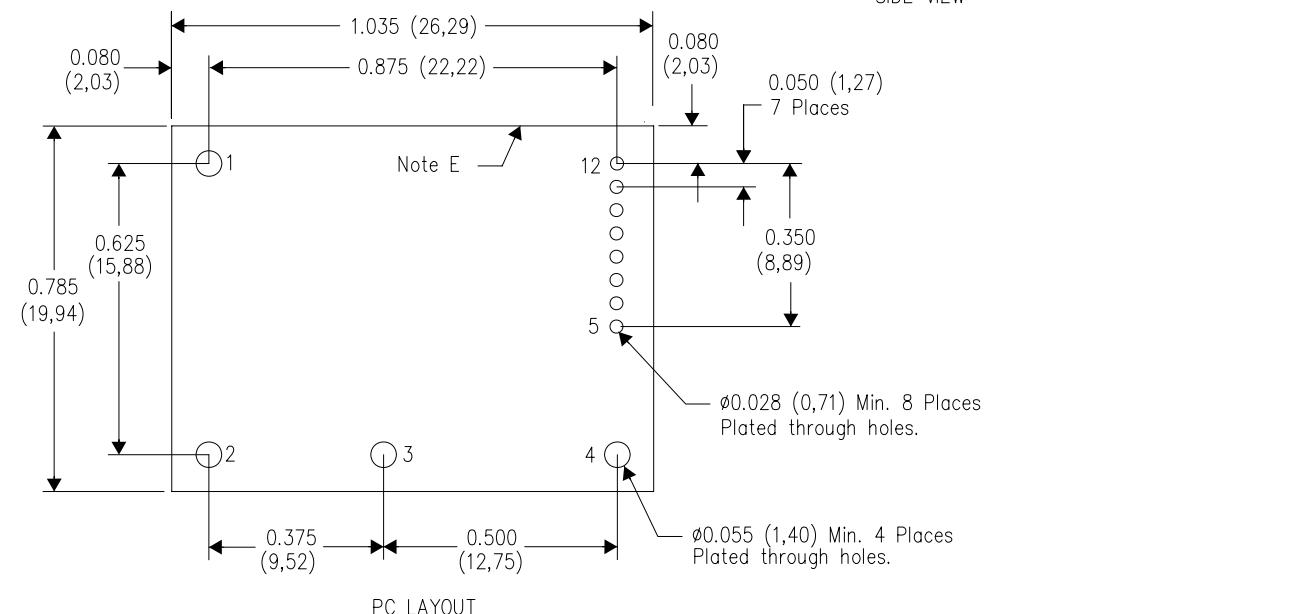
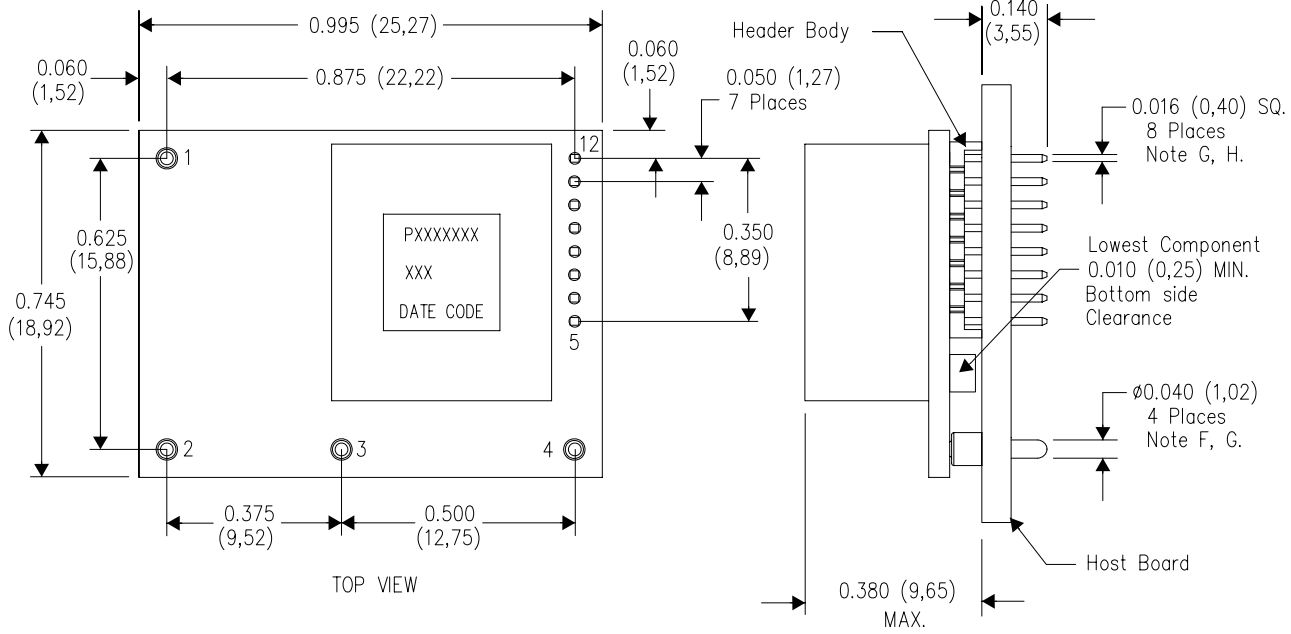


MECHANICAL DATA

EGP (R-PDSS-T12)

DOUBLE SIDED MODULE



4209185/C 02/10

- NOTES:
- A. All linear dimensions are in inches (mm).
 - B. This drawing is subject to change without notice.
 - C. 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
 - D. 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
 - E. Recommended keep out area for user components.
 - F. Pins are 0.040" (1,02) diameter with 0.070" (1,78) diameter standoff shoulder.
 - G. Header pins are 0.016 (0,40) SQ.
 - H. All pins: Material - Copper Alloy
Finish - Tin (100%) over Nickel plate

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